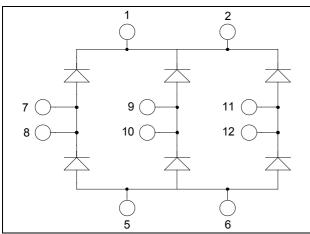


3 Phase rectifier bridge Power Module





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All multiple inputs and outputs must be shorted together 1/2; 5/6; 7/8; 9/10; 11/12

Application

- Input rectifiers for inverter
- Battery DC power supply

Features

- High blocking voltage
- High surge current
- Low leakage current
- Very low stray inductance
 - Symmetrical design
- High level of integration

Benefits

- Solderable terminals for easy PCB mounting
- Direct mounting to heatsink (isolated package)
- Low profile
- RoHS compliant

Absolute maximum ratings

| Symbol | Parameter | | | Max ratings | Unit | |
|-----------|---|--------|---------------------|-------------|------|--|
| V_R | Maximum DC reverse Voltage | | | 1600 | V | |
| V_{RRM} | Maximum Peak Repetitive Reverse Voltage | | | 1000 | v | |
| I_F | DC Forward Current | | $T_C = 80$ °C | 90 | ٨ | |
| I_{FSM} | Non-Repetitive Forward Surge Current | t=10ms | $T_J = 45^{\circ}C$ | 850 | А | |

These Devices are sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed. See application note APT0502 on www.microsemi.com



All ratings @ $T_j = 25$ °C unless otherwise specified

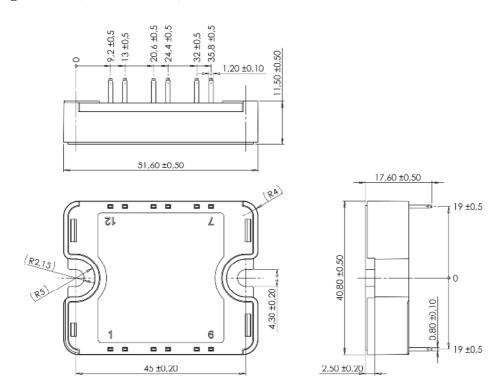
Electrical Characteristics

| Symbol | Characteristic | Test Conditions | | Min | Typ | Max | Unit |
|------------------|-----------------------------|-----------------|---------------------|-----|-----|-----|------|
| I_R | Reverse Current | $V_R = 1600V$ | $T_j = 25^{\circ}C$ | | 50 | | μA |
| | | | $T_j = 125$ °C | | 4 | | mA |
| $V_{\rm F}$ | Forward Voltage | $I_F = 90A$ | $T_j = 25^{\circ}C$ | | 1.3 | | V |
| | | | $T_j = 125$ °C | | 1.1 | | · |
| V_{T} | On – state Voltage | | | | 0.8 | | V |
| r_{T} | On – state Slope resistance | | | | 4.8 | | mΩ |

Thermal and package characteristics

| Symbol | Characteristic | | | Min | Typ | Max | Unit |
|-------------------|---|-------------|----|------|-----|------|------|
| R_{thJC} | Junction to Case Thermal Resistance | | | | | 0.85 | °C/W |
| V _{ISOL} | RMS Isolation Voltage, any terminal to case t =1 min, 50/60Hz | | | 4000 | | | V |
| T_{J} | Operating junction temperature range | | | -40 | | 150 | |
| T _{STG} | Storage Temperature Range | | | -40 | | 125 | °C |
| $T_{\rm C}$ | Operating Case Temperature | | | -40 | | 100 | |
| Torque | Mounting torque | To heatsink | M4 | 2 | | 3 | N.m |
| Wt | Package Weight | | | | | 80 | g |

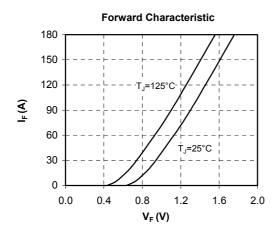
SP1 Package outline (dimensions in mm)

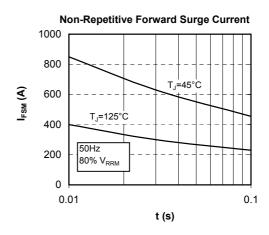


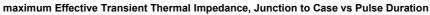
See application note 1904 - Mounting Instructions for SP1 Power Modules on www.microsemi.com

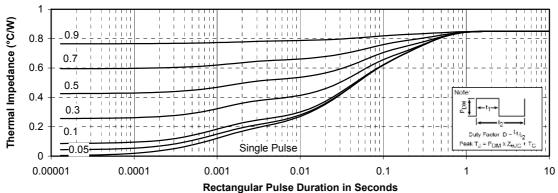


Typical Performance Curve











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